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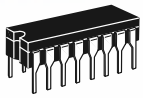
Hex D Master-Slave Flip-Flop with Reset

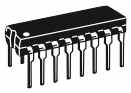
MC10H186

The MC10H186 is a hex D type flip–flop with common reset and clock lines. This MECL 10H part is a functional/pinout duplication of the standard MECL 10K family part, with 100% improvement in clock toggle frequency and propagation delay and no increase in power–supply current.

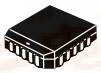
- Propagation Delay, 1.7 ns Typical
- Power Dissipation, 460 mW Typical
- Improved Noise Margin 150 mV (Over Operating Voltage and Temperature Range)
- Voltage Compensated
- MECL 10K–Compatible



L SUFFIX
CERAMIC PACKAGE
CASE 620–10



P SUFFIX
PLASTIC PACKAGE
CASE 648–08



FN SUFFIX
PLCC
CASE 775–02

MAXIMUM RATINGS

Characteristic	Symbol	Rating	Unit
Power Supply (V_{CC} = 0)	V_{EE}	–8.0 to 0	Vdc
Input Voltage (V_{CC} = 0)	V_I	0 to V_{EE}	Vdc
Output Current — Continuous — Surge	I_{out}	50 100	mA
Operating Temperature Range	T_A	0 to +75	°C
Storage Temperature Range — Plastic — Ceramic	T_{stg}	–55 to +150 –55 to +165	°C °C

ELECTRICAL CHARACTERISTICS (V_{EE} = –5.2 V ±5%) (See Note)

Characteristic	Symbol	0°		25°		75°		Unit
		Min	Max	Min	Max	Min	Max	
Power Supply Current	I_E	—	121	—	110	—	121	mA
Input Current High Pins 5,6,7,10,11,12 Pin 9 Pin 1	I_{inH}	 — — —	 430 670 1250	 — — —	 265 420 765	 — — —	 265 420 765	µA
Input Current Low	I_{inL}	0.5	—	0.5	—	0.3	—	µA
High Output Voltage	V_{OH}	–1.02	–0.84	–0.98	–0.81	–0.92	–0.735	Vdc
Low Output Voltage	V_{OL}	–1.95	–1.63	–1.95	–1.63	–1.95	–1.60	Vdc
High Input Voltage	V_{IH}	–1.17	–0.84	–1.13	–0.81	–1.07	–0.735	Vdc
Low Input Voltage	V_{IL}	–1.95	–1.48	–1.95	–1.48	–1.95	–1.45	Vdc

AC PARAMETERS

Propagation Delay	t_{pd}	0.7	3.0	0.7	3.0	0.7	3.0	ns
Set–up Time	t_{set}	1.5	—	1.5	—	1.5	—	ns
Hold Time	t_{hold}	1.0	—	1.0	—	1.0	—	ns
Rise Time	t_r	0.7	2.6	0.7	2.6	0.7	2.6	ns
Fall Time	t_f	0.7	2.6	0.7	2.6	0.7	2.6	ns
Toggle Frequency	f_{tog}	250	—	250	—	250	—	MHz
Reset Recovery Time ($t_{1–9+}$)	t_{rr}	3.0	—	3.0	—	3.0	—	ns

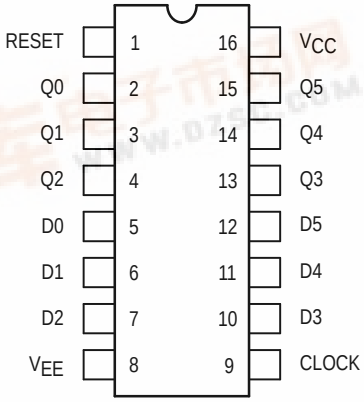
NOTE:
Each MECL 10H series circuit has been designed to meet the dc specifications shown in the test table, after thermal equilibrium has been established. The circuit is in a test socket or mounted on a printed circuit board and transverse air flow greater than 500 linear fpm is maintained. Outputs are terminated through a 50–ohm resistor to –2.0 volts.

CLOCKED TRUTH TABLE

R	C	D	Qn+1
L	L	X	Qn
L	H *	L	L
L	H *	H	H
H	L	X	L

* A clock H is a clock transition from a low to a high state.

DIP PIN ASSIGNMENT



Pin assignment is for Dual–in–Line Package. For PLCC pin assignment, see the Pin Conversion Tables on page 6–11 of the Motorola MECL Data Book (DL122/D).

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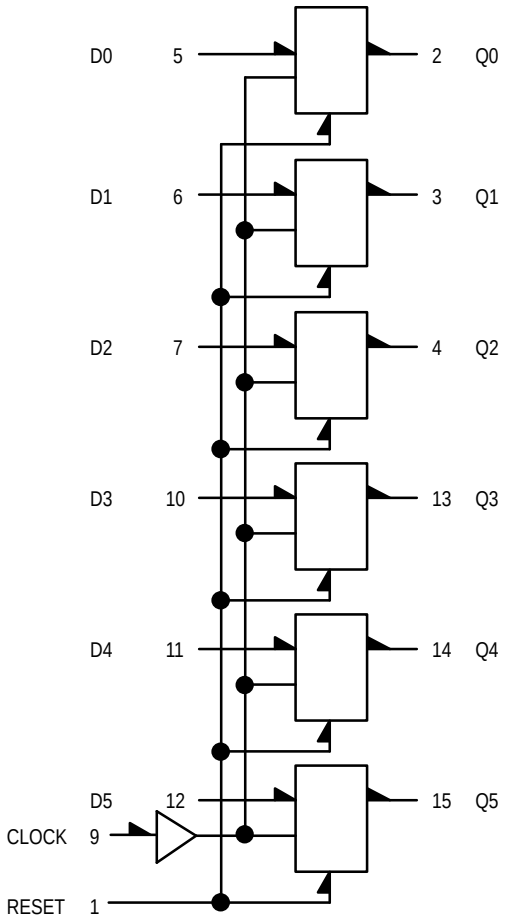
APPLICATION INFORMATION

The MC10H186 contains six high–speed, master slave type “D” flip–flops. Data is entered into the master when the clock is low. Master–to–slave data transfer takes place on the positive–going Clock transition. Thus outputs may change only on a positive–going Clock transition. A change in the information present at the data (D) input will not affect the output information any other time due to the master–slave construction of this device. A common Reset is included in this circuit. **THE RESET ONLY FUNCTIONS WHEN THE CLOCK IS LOW.**

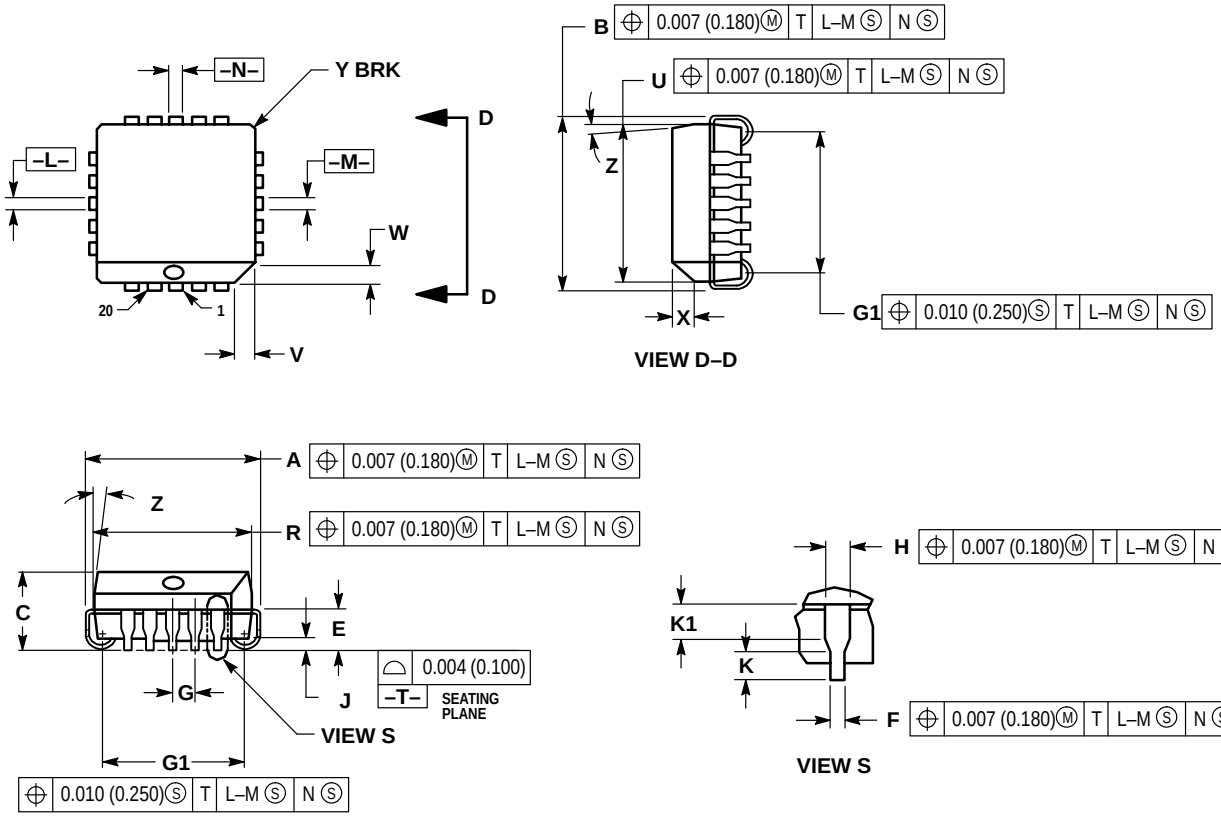
LOGIC DIAGRAM



V_{CC} = PIN 16
V_{EE} = PIN 8

OUTLINE DIMENSIONS

FN SUFFIX
PLASTIC PLCC PACKAGE
CASE 775–02
ISSUE C

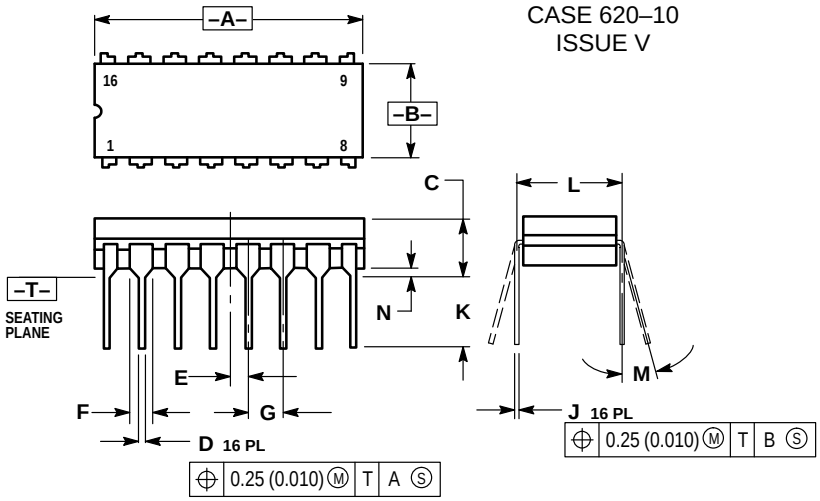


NOTES:
1. DATUMS –L–, –M–, AND –N– DETERMINED WHERE TOP OF LEAD SHOULDER EXITS PLASTIC BODY AT MOLD PARTING LINE.
2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM –T–, SEATING PLANE.
3. DIMENSIONS R AND U DO NOT INCLUDE MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE.
4. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
5. CONTROLLING DIMENSION: INCH.
6. THE PACKAGE TOP MAY BE SMALLER THAN THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
7. DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.385	0.395	9.78	10.03
B	0.385	0.395	9.78	10.03
C	0.165	0.180	4.20	4.57
E	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050 BSC		1.27 BSC	
H	0.026	0.032	0.66	0.81
J	0.020	—	0.51	—
K	0.025	—	0.64	—
R	0.350	0.356	8.89	9.04
U	0.350	0.356	8.89	9.04
V	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
X	0.042	0.056	1.07	1.42
Y	—	0.020	—	0.50
Z	2 °	10 °	2 °	10 °
G1	0.310	0.330	7.88	8.38
K1	0.040	—	1.02	—

OUTLINE DIMENSIONS

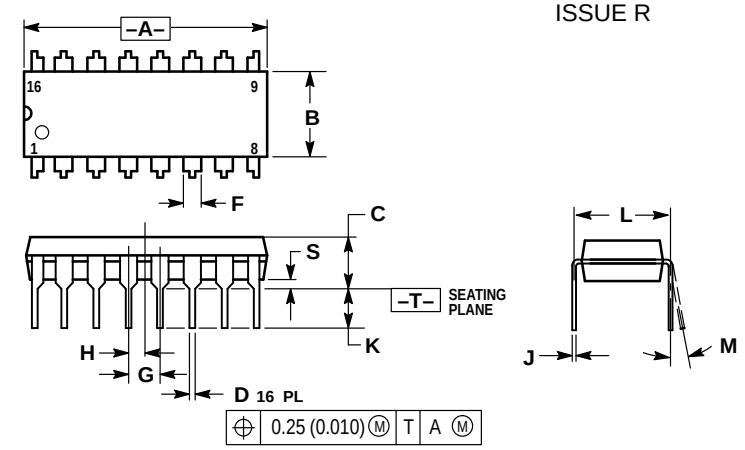
L SUFFIX
CERAMIC DIP PACKAGE
CASE 620–10
ISSUE V



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIMENSION F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.750	0.785	19.05	19.93
B	0.240	0.295	6.10	7.49
C	—	0.200	—	5.08
D	0.015	0.020	0.39	0.50
E	0.050 BSC		1.27 BSC	
F	0.055	0.065	1.40	1.65
G	0.100 BSC		2.54 BSC	
H	0.008	0.015	0.21	0.38
K	0.125	0.170	3.18	4.31
L	0.300 BSC		7.62 BSC	
M	0 °	15 °	0 °	15 °
N	0.020	0.040	0.51	1.01

P SUFFIX
PLASTIC DIP PACKAGE
CASE 648–08
ISSUE R



NOTES:
1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

	INCHES		MILLIMETERS	
DIM	MIN	MAX	MIN	MAX
A	0.740	0.770	18.80	19.55
B	0.250	0.270	6.35	6.85
C	0.145	0.175	3.69	4.44
D	0.015	0.021	0.39	0.53
F	0.040	0.70	1.02	1.77
G	0.100 BSC		2.54 BSC	
H	0.050 BSC		1.27 BSC	
J	0.008	0.015	0.21	0.38
K	0.110	0.130	2.80	3.30
L	0.295	0.305	7.50	7.74
M	0 °	10 °	0 °	10 °
S	0.020	0.040	0.51	1.01

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